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A stable, efficient textile-based flexible perovskite solar cell with improved washable and deployable capabilities for wearable device applications†

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Organic–inorganic hybrid perovskite solar cells (PVSC) have appeared as promising high power-per-weight power systems for wearable electronic devices. Herein, we utilized a low-temperature electrodeposited tin oxide (SnO₂) electron-transporting layer (ETL) coupled with a thin PCBM ETL and a functional encapsulating layer to realize an efficient, stable textile-based flexible PVSC. We first demonstrated that an easily accessible elastomer can serve as an effective encapsulating material for the fabricated flexible PVSC, as exemplified by the largely improved ambient stability and waterproof properties. Furthermore, we established that the good adhesive properties generated by the elastomer can largely enrich the deployable capability of the completed device stack as evidenced by the effortless integration of a completed device stack onto a textile. As a result, a ~15% textile-based flexible PVSC with improved ambient stability and washable capability was demonstrated. A proof-of-concept device was successfully integrated with other electronic devices on a unitary textile to serve as an efficient power supply system for wearable electronic devices. The findings revealed in this work can promote the future potential applications of PVSCs in wearable device applications.

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Introduction

The rapid progress of human civilization has been accompanied with a large demand for energy. Therefore, the development of renewable clean energy has become an urgent issue for this generation. From the sustainable perspective, solar energy has emerged as the most promising candidate due to its almost inexhaustible access and high radiation energy. More importantly, it requires no extra fuels and produces few by-products when supplying power silently.

Among the rapid tide of photovoltaic techniques, organic–inorganic hybrid halide perovskite materials with a formula of ABX₃ (A = Cs⁺, CH₃NH₃⁺, or CH(NH₂)₂⁺; B = Sn²⁺ or Pb²⁺; X = Cl[−], Br[−], or I[−]) have recently attracted worldwide attention since they not only possess exceptional opto-physical properties but also own facile solution processability.^{1–7} Such appealing features have enabled them to be considered as the most transformative photovoltaic technology nowadays.⁷ Currently, the state-of-the-art power conversion efficiency (PCE) of the

perovskite solar cells (PVSCs) on rigid glass substrates has reached over 22% despite its only few year's development.⁸

Generally, PVSCs can be divided into two types, n-i-p and p-i-n structures, according to the sequence of the employed charge-transporting layers (CTLs). The prototypal PVSC is based on a conventional n-i-p configuration as evolved from the mesoporous dye-sensitized solar cells (DSSCs), which consists of a transition metal oxide (TMO) scaffold serving as an electron-transporting layer (ETL) at device's bottom side. Originally, the TMO is mainly based on TiO_x and requires elaborate preparation procedures involving high-temperature sintering.^{9–13} However, such sophisticated processes would imperceptibly increase the production costs and limit the substrate choice.¹⁴ Further, it impedes the widespread applications of the derived devices in the flexible and wearable electronics, for which polymeric substrates with low glass transition temperatures were usually employed.¹⁵ For this reason, versatile low-temperature procedures are developed for TiO_x. One example is that Kim *et al.* have adopted the atomic layer deposition (ALD) technology to prepare a TiO_x layer ETL at a reduced temperature to realize an efficient (PCE: >12%) flexible conventional PVSC with satisfactory mechanic stability under 1000 bending cycles for a bending radius of 10 mm.¹⁶

Meanwhile, other TMOs besides TiO_x with low-temperature processed capability are continuously exploited in the past few years, such as ZnO, SnO₂, Zn₂SnO₄, and BaSnO₃.^{17–19} Among them, SnO_x-based TMO has attracted the most research

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attention due to its much higher electron mobility than TiO_x . Several groups have individually developed distinct synthetic processes to prepare SnO_x -based films at reduced temperatures to facilitate their electron-transporting properties to realize efficient PVSCs.^{20,21} Recently, we have also utilized the electrochemical deposition technique to successfully prepare a high-quality SnO_2 film at a low temperature below 100 °C to fabricate efficient conventional PVSCs.¹⁵ These aforementioned achievements in developing efficient low-temperature processed ETLs indeed promote the future applications of PVSCs as promising high power-per-weight energy source for unmanned aerial vehicles for environmental and industrial monitoring, rescue and emergency response, and tactical security applications.²²

While the current state-of-the-art PCE of PVSC can rival the performance of traditional inorganic photovoltaic techniques, more research focuses in this field have been shifted to improve its long-term device stability. The perovskite materials have been documented to be susceptible to moisture, thermal, and intense illumination.^{23–27} In this regard, the encapsulation of PVSC will play a pivotal role to sustain its long-term stability for real operation. At present, barriers and ALD technologies are the most commonly methods used for device encapsulation. For the device fabricated on the regular rigid substrates, it is quite common to employ a thin glass cover slip to cover the completed device stack, followed by sealing with UV curable epoxy resin.^{28–30} However, the UV exposure procedure needs to be carefully controlled to avoid deteriorating the perovskite layer. As for the flexible devices, the encapsulation is more challenging. Thus far, utilizing membranes^{31,32} or ALD technology are considered as the most feasible approaches for encapsulating flexible PVSCs.^{29,30,33,34}

In this study, extended from our previous work,¹⁵ we employed the electrodeposited SnO_2 film onto a flexible substrate to fabricate a flexible PVSC. Surprisingly, it is revealed that the quality of the low-temperature electrodeposited SnO_2 film on the flexible substrate is inferior to the case deposited on regular rigid substrate, attributed to the lower conductivity of ITO on the flexible substrate. Fortunately, this deficiency can be compensated by introducing an additional fullerene layer on top of SnO_2 film, as a common strategy adopted in regular conventional PVSCs. Furthermore, we manifested that an easily accessible elastomer can effectively encapsulate the fabricated flexible PVSC, as exemplified by its largely improved ambient stability and waterproof property. More intriguingly, its respectable adhesive property can also facilitate the effortless integration of the completed device stack onto a textile substrate. As a result, a ~15% textile-based flexible PVSC with improved ambient stability and washable capability was demonstrated. A proof-of-concept device was successfully integrated with other electronic devices on a unitary textile to serve as an efficient power supply system, demonstrating its promising potential for the wearable device applications.

Results and discussion

Recently, we have employed a low-temperature electrodeposited SnO_2 film to serve as an efficient ETL to realize an efficient PVSC

on regular rigid ITO substrate.¹⁵ Regarding its low-temperature manufacturing process, we continuously explored its efficacy in fabricating efficient flexible PVSCs. An ITO/polyethylene naphthalate (PEN) substrate was herein chose to compare with the regular rigid ITO/glass substrate. It has been acknowledged that the ITO/flexible substrates (like PEN, terephthalate (PET), and polyimide (PI))-based devices typically possess inferior performance compared to the rigid ITO/glass counterparts due to the brittle and unsatisfactory bendable nature of ITO.³⁵

Fig. 1 presents the high-resolution TEM (HR-TEM) image and selected area electron diffraction (SAED) of the prepared SnO_2 film. As can be seen, the inset fast Fourier transform (FFT) pattern shows clear ring patterns associated with diffraction spots. It indicates the highly crystalline structures of SnO_2 with random orientation, being consistent to the morphology observed in the HR-TEM image.

We first surprisingly observed that the quality of the electrodeposited SnO_2 on the ITO/PEN substrate is much worse than the film deposited on the regular ITO/glass substrate. In contrast to the homogeneous surface morphology observed in the rigid substrate (Fig. S1†), the morphology of the SnO_2 deposited on the ITO/PEN substrate is quite discrete and isolated island-like domains was clearly observed as shown in Fig. 2a. This discrepancy might originate from the lower conductivity of ITO on PEN than on glass since the brittleness of ITO might engender more defects existed in the substrate, which unavoidably leads to the less efficient electrodeposition of SnO_2 film. Such incomplete surface coverage will also deteriorate the performance of its derived PVSC because the pin-hole formation could easily incur the shunting paths in the device.

To address this deficiency, we therefore introduced an additional PCBM layer onto the deposited SnO_2 layer. The fullerene materials have not only been demonstrated as efficient ETLs for PVSCs,^{36,37} but also been proven as sufficient surface modifiers of TMO-based ETLs to facilitate the charge transfer and transport between them and perovskite in the conventional n-i-p PVSCs.³⁸ Shown in Fig. 2b and c are the SEM surface images of the SnO_2 /PCBM and simplex PCBM layers deposited on the ITO/PEN substrates, respectively. As can be seen, the simplex PCBM clearly exhibited a featureless surface morphology, revealing its superior film formation capability. After adding this layer onto the pre-electrodeposited SnO_2 layer,

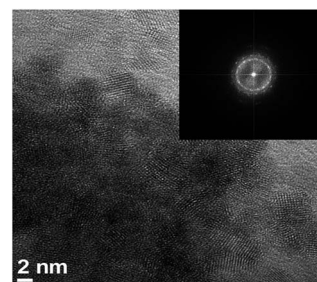


Fig. 1 HRTEM micrograph of the electrodeposited SnO_2 film with the corresponding insert FFT pattern.



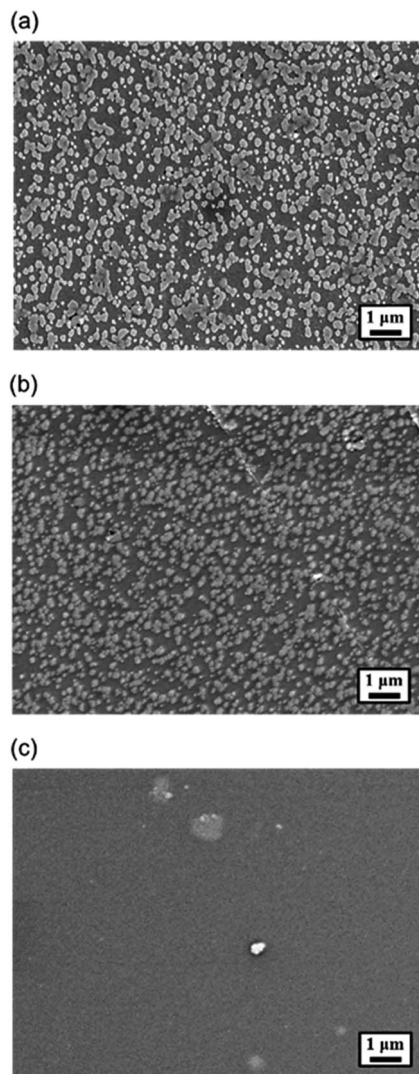


Fig. 2 The top-view SEM image of (a) the electrodeposited SnO_2 , (b) the electrodeposited SnO_2/PCBM , and (c) PCBM films on the ITO/PEN flexible substrate.

the originally rough surface was kind of flattened and the pristine sharp edges of discrete SnO_2 domains was smoothened, indicating that PCBM layer covered the entire surface to avoid any direct contact between perovskite and ITO electrode.

The local surface morphology of these studied ETLs on the ITO/PEN substrate was further characterized using AFM as presented in Fig. 3. As seen, the in-plane continuity of the prepared films is identified, wherein the discrete large grains were observed in the SnO_2 film, consistent with its corresponding SEM image (Fig. 2a). Notably, the root-mean-square (RMS) roughness (R_q) for the SnO_2 film and SnO_2/PCBM film was evaluated to be 19.4 nm and 12.1 nm, respectively. The significant decrease in R_q affirms the passivation function of the PCBM layer. The smoothened surface of this bilayered ETL is essential for realizing homogeneous deposition of perovskite to result in high performance.

In addition to the morphological issue, high transparency is another important index for a qualified ETL for achieving high

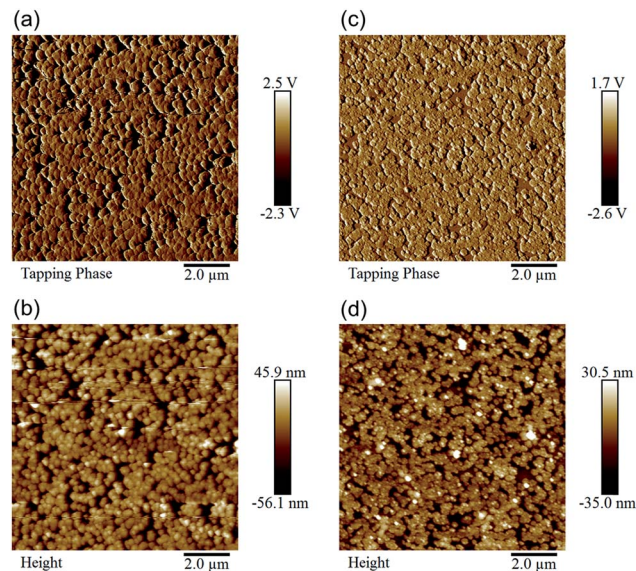


Fig. 3 The AFM phase (a and c) and height (b and d) images of the electrodeposited SnO_2 film (a and b) and the electrodeposited SnO_2/PCBM (c and d) layers on the ITO/PEN flexible substrate.

efficiency since it can prevent the parasitical absorption of perovskite absorber. Fig. 4a compared the transmittance spectra of the electrodeposited SnO_2 and the electrodeposited SnO_2/PCBM films on the ITO/PEN substrates. As can be seen, the bilayered ETL can still possess a reasonable transmittance of $\sim 80\%$ in the range of wavelengths large than 600 nm despite the slightly decreased transmittance below 600 nm as a result of the absorption of the PCBM layer. Note that the transmittance

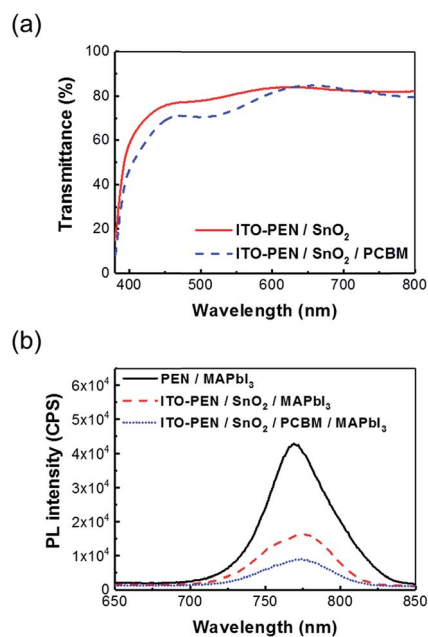


Fig. 4 (a) The optical transmittance of the studied ETLs deposited on ITO/PEN substrate and (b) the PL spectra of perovskite and perovskite deposited on the studied ETLs.



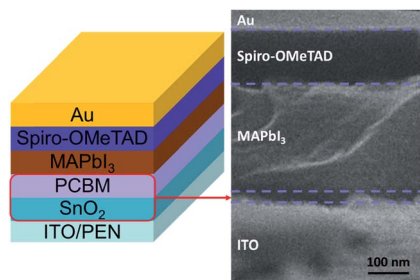


Fig. 5 Device structure and the corresponding cross-sectional SEM image.

dramatically decreased at ~ 400 nm which is attributed to the absorption of ITO/PEN substrate.

In order to evaluate the efficiency of charge transfer between the prepared ETLs and perovskite layer, the photoluminescence (PL) of the ETL/perovskite samples were measured accordingly as portrayed in Fig. 4b. It clearly showed that the PL quenching of $\text{CH}_3\text{NH}_3\text{PbI}_3$ deposited on a SnO_2/PCBM film is higher than the one grown on a simplex SnO_2 film, suggesting the facilitated charge transfer between SnO_2/PCBM and perovskite. This result is expectable as considering the improvement in morphology as discussed earlier.

To examine the efficacy of the prepared ETLs on a flexible substrates, a convention PVSC consisting of PEN/ITO/studied ETLs/ $\text{CH}_3\text{NH}_3\text{PbI}_3$ /Spiro-OMeTAD/Au (Fig. 5, left) was primarily fabricated and the cross-sectional SEM image of the representative device using SnO_2/PCBM ETL was present in Fig. 5 (right) to illustrate its well multi-layered architecture, in which the thickness of SnO_2 , $\text{CH}_3\text{NH}_3\text{PbI}_3$, and Spiro-OMeTAD is estimated to be ~ 20 nm, 250 nm, and 150 nm, respectively.

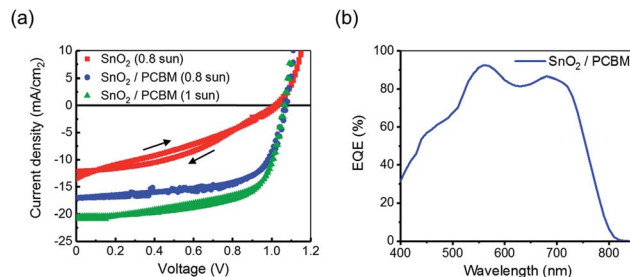
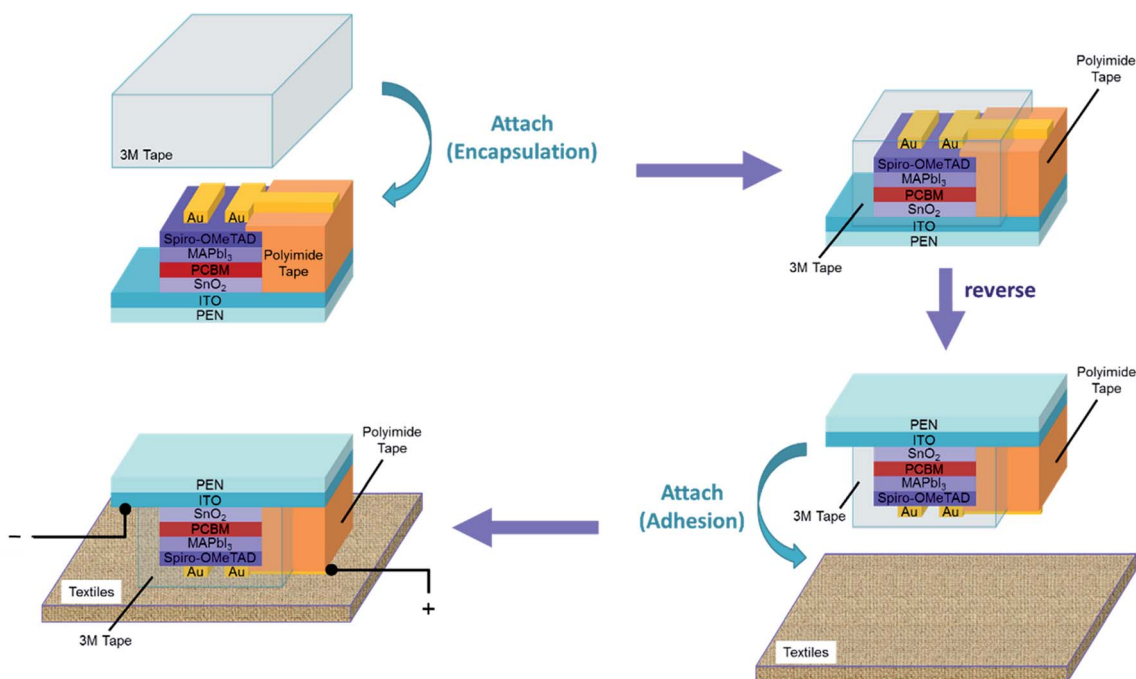


Fig. 6 (a) The J - V curves of the studied flexible PVSCs using the electrodeposited SnO_2 ETL and SnO_2/PCBM ETL. (b) EQE of the PVSC using SnO_2/PCBM ETL under 1 sun.

As a point of note, in order to develop a stable flexible PVSC, we capped the completed device with a ductile elastomer (Scheme 1). As discussed earlier, a thin glass cover slip is the most widely adopted encapsulating technique to date. Its rigidity however impedes the further applications on flexible electronics. Hence, the ductile elastomer was chose as the encapsulating material regarding its easy accessibility, decent adhesion, and good isolation for external substances. Shown in Fig. S2† is the performance comparison of the control devices using a glass slide and an elastomer as the encapsulating layer. Encouragingly, both encapsulating materials can yield similar performance, qualifying the commercial elastomer as a feasible encapsulating material. Provided the good adhesive property of the elastomer, it might not only can serve as a laudable encapsulating material for flexible PVSCs but also can facilitate the fabrication of textile-based PVSCs (Scheme 1), enriching their application values.

Fig. 6a presented the J - V characteristics of the encapsulated flexible PVSCs using different ETLs measured under 0.8 sun and



Scheme 1 Illustration of the fabrication of the textile-based flexible PVSC via a functional encapsulating layer in this work.



Table 1 Device parameters of the studied flexible PVSCs using SnO₂ ETL and SnO₂/PCBM ETL

Electron-transporting layer		V_{OC} (V)	J_{SC} (mA cm ⁻²)	FF	PCE (%)
SnO ₂ (0.8 sun) ^b	F ^a	1.03	-13.47	0.31	5.4
	R ^a	1.02	-12.16	0.41	6.3
SnO ₂ /PCBM (0.8 sun)	F ^a	1.08	-17.07	0.63	14.5
	R ^a	1.06	-17.05	0.65	14.8
SnO ₂ /PCBM (1 sun)	F ^a	1.07	-20.90	0.62	13.9
	R ^a	1.06	-20.53	0.66	14.3

^a F: forward-bias sweep (-0.1 V → 1.2 V); R: reverse-bias sweep (1.2 V → -0.1 V). ^b Time of electrodeposition for SnO₂: 120 s.

1.0 sun illumination and the corresponding photovoltaic parameters are summarized in Table 1. It is deserved to mention that we found out there is no performance difference before and after integrating the encapsulated PVSC on the textile (Scheme 1). This result reflects the merit of using elastomer as the encapsulating materials and demonstrates its convenience of integration onto arbitrary substrates.

As clearly shown, under 0.8 sun illumination, the control device using simplex electrodeposited SnO₂ ETL yielded a low photocurrent along with a poor fill factor (FF), which can be traced to the high series resistance (R_s) and low shunt resistance (R_{sh}) caused by low-quality SnO₂ layer as discussed earlier. Its discontinuous morphology associated with isolated island-like domains impedes efficient charge transport and beget severe charge recombination. However, after introducing a thin PCBM layer, the resultant performance can be significantly improved. As shown, under 0.8 sun illumination, the V_{OC} was improved from 1.02 V to 1.06 V, J_{SC} was raised from 12.16 mA cm⁻² to 17.05 mA cm⁻², and FF was enhanced from 0.41 to 0.65, corresponding to an increased PCE from 6.3% to 14.8%. This result clearly highlights the pivotal role of PCBM in our fabricated flexible device, which not only smoothens the rough surface of electrodeposited SnO₂ film but also facilitates the charge transfer and transport at the corresponding interface. While this top-performing device was measured under 1 sun illumination, the resultant J_{SC} was accordingly increased while the V_{OC} and FF were remained, for which a PCE of 14.3% comparable to the value measured under 0.8 sun illumination is obtained. The external quantum efficiency (EQE) spectrum of this optimized SnO₂/PCBM-based device is presented in Fig. 6b. As seen, it showed a broad photo-response across 400 nm to 800 nm, in a good agreement with the light-harvesting behavior of CH₃NH₃PbI₃.³⁹ We note that the lower EQE efficiency across from 400 nm to 520 nm might be ascribed to the parasitic absorption from the hybrid ETL and the substrate and the dip at ~630 nm might be attributed to the reduced absorption of the perovskite as a result of optical interference.⁴⁰

Notably, we also fabricated the devices on the regular ITO/glass substrate for a fair comparison and the results were shown in Fig. S3 and Table S1.† As shown, different to the case of using flexible substrate, there is only slight performance difference between the SnO₂-based device and SnO₂/PCBM-based

device. Both devices exhibited hysteresis-free J - V characteristics and yields PCEs of ~14%. This suggests the high-quality SnO₂ can be successfully achieved on the ITO/glass substrate through electrodeposition¹⁵ and the additional PCBM interlayer therefore plays a less important role. On the other hand, we have also investigated the feasibility of replacing SnO₂ ETL with a PCBM ETL on the flexible ITO/PFN substrate. As shown in Fig. S4 and Table S2,† the device using a simplex PCBM ETL yield a lower J_{SC} than the SnO₂-based devices. In addition, it showed severe device hysteresis as reported in the literature.⁴¹

We next evaluated the ambient stability of the fabricated textile-based flexible PVSC. In order to understand the encapsulating efficacy of elastomer, flexible PEN-based devices with and without encapsulation were compared in parallel in an ambient condition with a controlled humidity of 65%. As shown in Fig. 7, the encapsulated textile-based device showed a much enhanced ambient stability, for which over 70% of initial PCE can be maintained after 425 h storage. In contrast, the unencapsulated device was quickly degraded within 100 h due to the poor surface barrier properties of Spiro-OMeTAD⁴² and the fragility of perovskite to oxygen and moisture.^{43,44} As mentioned above, our device shows good performance at first days of operation but possesses poor stability without encapsulation, indicating that Spiro-OMeTAD is not suitable for serving as an effective surface barrier for H₂O and O₂ diffusion. Further optimization using more advanced HTLs is in progress in our group.

Besides the ambient stability, we also examined the water-resistance of the textile-based PVSC in an extreme case, for which the whole device stack was immersed into water for a certain period of time as shown in Fig. 8a. Presented in Fig. 8b is a photograph comparing the devices with and without encapsulation. As can be clearly seen, the color of the unencapsulated part was immediately (<1 s) turned into yellow and

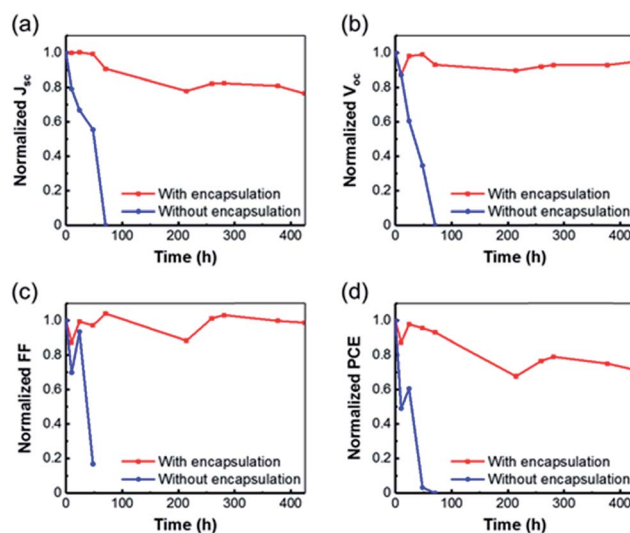


Fig. 7 Device performance of the textile-based flexible PVSC (red square) and the reference PVSC without encapsulation (blue dot) as a function of storage time in an ambient environment (humidity: ~65%; $T = 25$ °C). (a) Normalized J_{SC} , (b) normalized V_{OC} , (c) normalized FF, and (d) normalized PCE.



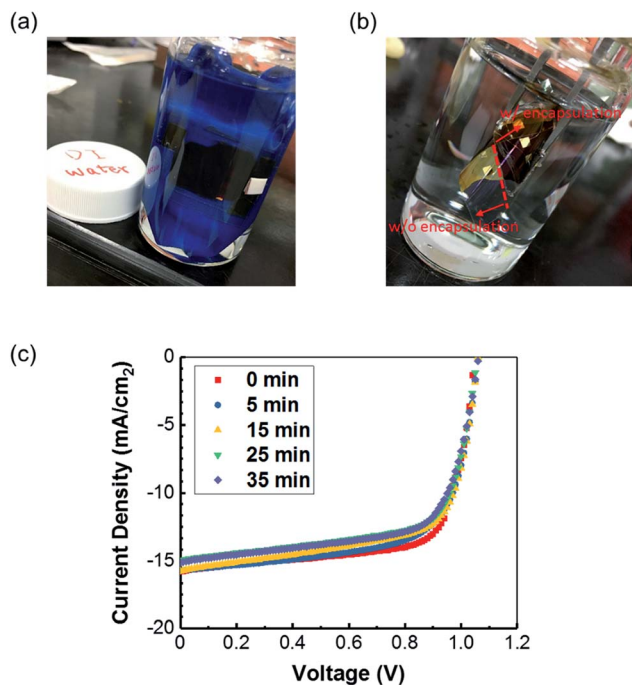


Fig. 8 Photos of (a) the textile-based flexible PVSC immersing in water and (b) a designed device with and without encapsulation immersing in water. (c) The J - V curve of the textile-based flexible PVSC as a function of immersing time in water.

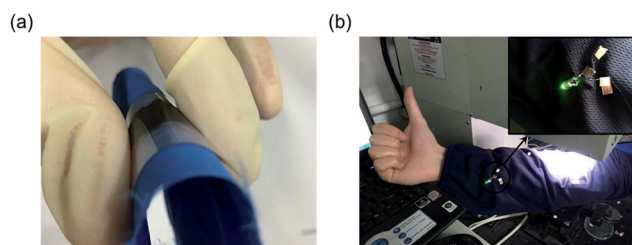


Fig. 9 Photos of (a) the textile-based flexible PVSC and (b) a commercial LED lit up by the fabricated textile-based flexible PVSCs under 0.8 sun illumination.

completely lost the photovoltaic performance. Whereas, the encapsulated device can still preserve a comparable performance after 35 minute immersion in water as displayed in Fig. 8c, for which only a slight decrease in J_{sc} was observed. These encouraging results manifested that the elastomer can effectively isolate the penetration of air and water into device, enhancing the washable abilities of the encapsulated flexible PVSC, which is very critical for the future potential applications in the wearable devices.

With the successful realization of an efficient textile-based flexible PVSC (Fig. 9a), we further utilized this proof-of-concept device to demonstrate some possible applications in wearable electronics. For example, we arranged the integrated PVSCs on textile in series connection to successfully light up a commercial light-emitting diode integrated on the same textile as displayed in Fig. 9b. This result suggests our novel

device design not only can deliver a stable and efficient flexible PVSC but also can enrich the device's functionality in wearable devices to serve as an efficient power supply system.

Conclusion

In this work, we successfully developed an efficient textile-based flexible PVSC by employing a low-temperature electrodeposited SnO₂ ETL coupled with a thin PCBM ETL and a functional encapsulating layer. Different to our previous work,¹⁵ we unexpectedly revealed that the quality of the low-temperature electrodeposited SnO₂ film on flexible ITO/PEN substrate is inferior to the film deposited on regular rigid substrate, attributed to the lower conductivity of ITO on the flexible substrate. Fortunately, introducing an additional PCBM layer can compensate this deficiency. Besides, we demonstrated that an easily accessible elastomer can effectively encapsulate the fabricated flexible PVSC, as exemplified by the largely improved ambient stability and waterproof property. Moreover, benefiting from its good adhesive property, the completed device stack can be effortlessly integrated onto a textile substrate, showing a much improved deployable capability. As a result, a $\sim 15\%$ textile-based flexible PVSC with improved ambient stability and washable capability was demonstrated. A proof-of-concept device was successfully integrated with other electronic devices on the textile to serve as an efficient power supply system, demonstrating its promising potential for the wearable device applications.

Experimental

Preparation of SnO₂ via electrodeposition method

All materials and chemicals were used as received unless stated otherwise. The electrodeposition of SnO₂ films on indium tin oxide (ITO)-coated glass substrates follows our previously reported method.¹⁵ The ITO/PEN substrates were cleaned with detergent and then sequentially ultra-sonicated in deionized water, acetone, and isopropanol for 15 min, respectively. Afterward, the substrates were dried at 120 °C for 10 min, followed by UV-ozone exposure for 20 min. The electrochemical deposition was performed on a CHI 611D electrochemical analyzer using a three-electrode cell in which ITO was used as a working electrode. A platinum wire was used as a counter-electrode and an Ag/AgCl electrode (with a potential at +0.22 V vs. standard hydrogen electrode) was used as the reference electrode. The deposition solution is made of 20 mM SnCl₂, 100 mM NaNO₃ and 75 mM HNO₃ dissolved in de-ionized water. For the deposition of SnO₂ thin film, ITO/PEN without using a seed layer was placed in deposition bath and a constant voltage of -0.4 V vs. Ag/AgCl reference electrode was applied for 120 s under 50 °C.

Fabrication of planar perovskite solar cells

All fabrication processes except for the SnO₂ electrodeposition were operated in an N₂-filled glove box. A thin PCBM (~ 10 mg ml⁻¹ in chlorobenzene) layer was spin-coated onto the SnO₂ coated-



ITO/PEN substrate at 1000 rpm for 60 s. A 1 M precursor solution of perovskite was prepared by dissolving lead iodide (PbI_2 , 1 mmol) and methylammonium iodide ($\text{CH}_3\text{NH}_3\text{I}$, 1 mmol) in a 7 : 3 v/v γ -butyrolactone/dimethyl sulfoxide binary solvent mixture. The perovskite layer was prepared through the solvent washing technique by consecutive three steps: 500 rpm for 5 s, 1000 rpm for 45 s, and 5000 rpm for 40 s. During the spin-coating, anhydrous toluene was *in situ* dropped at 20 s prior to the stop to facilitate the conversion of intermediate iodo-plumbate anions to perovskite.^{45,46} The deposited perovskite film was subsequently annealed at 100 °C for 10 min. The hole-transporting layer (HTL) was deposited by spin coating a 40 mg ml^{-1} concentration of 2,2',7,7'-tetrakis(*N,N*-di-*p*-methoxyphenylamine)-9,9'-spirobifluorene (spiro-OMeTAD) solution in chlorobenzene added with 33 μl of lithium bis(trifluoromethanesulfonyl) imide (Li-TFSI) solution (175.1 mg Li-TFSI in 1 ml acetonitrile, Sigma-Aldrich, 99.8%) and 16 μl of 4-*tert*-butyl pyridine (*t*BP) at the speed of 2000 rpm for 60 s. After depositing the HTL, the samples were stored inside a desiccator for a designated period of time. Finally, Au electrodes were thermally evaporated under high vacuum through a shadow mask to complete the device fabrication.

Integration of fabricated device on textiles

The integration of the fabricated flexible PVSCs on textiles was illustrated in Scheme 1. The 3MTM acrylic elastomer (3MTM VHBTM 4905) was used as received and the textiles were provided by Taiwan textile research institute (TTRI). The 3MTM elastomer was first attached on device's top side which deployed metal electrodes and then the whole device stack were reversed to adhere to the textile.

Characterization

Transmission electron microscope (TEM) images and selected-area electron diffraction (SAED) pattern were taken using a microscope (FEI Tecnai G2 20) operated at 200 keV to observe the crystallographic orientation of the electrodeposited SnO_2 film. Scanning electron microscopy (SEM) imaging was taken using field emission scanning electron microscope (FE-SEM, JEOL JSM-6700F, Japan). Atomic force microscopy (AFM) imaging was performed on Innova (Bruker, Germany) AFM system in a tapping mode in air. The UV-vis transmission spectrum was recorded using a Hitachi U-4100 spectrophotometer. Photoluminescence (PL) spectra were measured by Horiba Fluorolog-3. For the current density-voltage (J - V) measurement, the devices (with an active area of 0.04 cm^2) were characterized under illumination of a Newport solar simulator (Newport Corp., Irvine, CA USA) with $\sim 800 \text{ W m}^{-2}$ (~ 0.8 sun) intensity calibrated with a silicon reference diode. The J - V characteristics were recorded using a source meter (Keithley 2400, USA) in reverse (from the open-circuit voltage (V_{OC}) to the short-circuit current (J_{SC})) and forward (from J_{SC} to V_{OC}) scan directions at a sweeping rate of 0.1 V s^{-1} . Reference ITO/glass-based device was characterized using the same conditions.

Stability of the integrated device (with encapsulation) on textiles and reference device without encapsulation was

monitored up to 425 h. The studied devices were stored in an ambient environment at 25 °C with a relative humidity of 65%. Water resistance test was carried out by immersing the integrated device into water without any further treatment. The tested device was took out at a certain period of time for performance checking and the residual water was gently wiped out by tissue prior to the J - V measurement.

Conflicts of interest

There are no conflicts to declare.

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